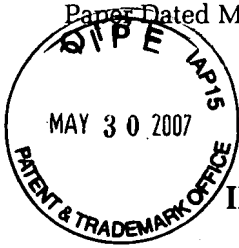


Appl. No. 10/529327
Paper Dated May 8, 2007



PATENT
Docket No: DKC 1060

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Hong et al)	
)	
SERIAL NO.: 10/529,327)	
)	
FILED: March 25, 2005)	Art Unit: 1714
)	
FOR: Flameproof Styrenic Resin)	Examiner: Szekely, P
Composition)	
)	

**INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. 1.56 AND
37 C.F.R.1.97-1.98**

Sir:

Enclosed is a PTO Form 1449 listing a reference for consideration by the Examiner. The cited U.S. patent applications are commonly owned with the above application. Copies of the published U.S. applications and U.S. patents are not enclosed. A copy of the unpublished application is enclosed as well as copies of any non-U.S. patent references. The Examiner is respectfully requested to consider the enclosed references and return an initialed copy of Form 1449 to Applicants. A Credit Card Form is attached.

Respectfully submitted,

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Telephone: 610 660 7786

05/31/2007 SSITHIB1 00000003 10529327

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313 on May 8, 2007

By 

U.S. Department of Commerce

ATTY. DOCKET NO.
DKC 1060SERIAL NO.:
10 529 327INFORMATION DISCLOSURE CITATION
IN AN APPLICATION

(Use several sheets if necessary)

APPLICANT:

HONG ET AL

FILING DATE:
MARCH 25, 2005GROUP:
1714

U.S. PATENT DOCUMENTS

EXAMINER INITIALS	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	2006 0183826	08/17/2006	Ryu et al.			02/06/2006
	2006 0189729	08/24/2006	Bae et al.			02/14/2006
	2006 0189730	08/24/2006	Hong et al.			02/14/2006
	2007 0032579	02/08/2007	Ku et al.			05/02/2006
	6 262 166	07/17/2001	Yoshida et al.			
	4 397 759	08/09/1983	Hancock			

FOREIGN PATENT DOCUMENTS

EXAMINER INITIALS	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
	JP 61-009450	01/17/1986	Japan				X

EXAMINER INITIALS	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)	
	<p>Abstract of published Japanese Application 61-009450 published January 17, 1986</p> <p>Copy of unpublished U.S. Serial No. 11 601 352 filed November 17, 2006 for Ku et al.</p> <p>Abstract of Korean Publication No. KR 2004 0058773 published July 5, 2004</p> <p>Abstract of Korean Publication No. KR 2004 0027104 published April 1, 2004</p> <p>Abstract of Korean Publication No. KR 2003 0030421 published April 18, 2003</p> <p>Abstract of Korean Publication No. KR 2001 0009848 published February 5, 2001</p> <p>Abstract of Korean Publication No. KR 2001 0083602 published September 1, 2001</p>	
EXAMINER	DATE CONSIDERED	

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

U.S. Department of Commerce INFORMATION DISCLOSURE CITATION IN AN APPLICATION <i>(Use several sheets if necessary)</i>	ATTY. DOCKET NO. DKC 1060	SERIAL NO.: 10 529 327
	APPLICANT: HONG ET AL	
	FILING DATE: MARCH 25, 2005	GROUP: 1714

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	3 639 506	05/21/1969	Haaf			
	3 789 901	02/05/1974	Rishovd			
	3 849 368	11/19/1974	Anderson et al.			
	3 883 613	05/13/1975	Cooper			
	4 273 881	06/16/1981	Otten			
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EXAMINER INITIALS	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)
	<p>Abstract of Korean Publication No. KR 2004 0003563 published January 13, 2004</p> <p>Abstract of Korean Publication No. KR 2003 0078189 published October 8, 2003</p> <p>Abstract of Japanese Publication No. JP 11343382 published Dec. 14, 1999</p> <p>Abstract of Japanese Publication No. JP 10195287 published July 28, 1998</p> <p>Abstract of Japanese Publication No. JP 60079048 published May 4, 1985</p> <p>Abstract of Japanese Publication No. JP 1140270 published May 25, 1999</p> <p>Abstract of Japanese Publication No. JP 2001040172 published Feb. 13, 2001</p> <p>Abstract of WO 98 11160 published March 19, 1998</p> <p>Abstract of WO 00 17268 published March 30, 2000</p>
EXAMINER	DATE CONSIDERED

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